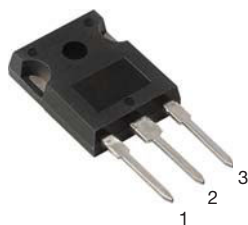
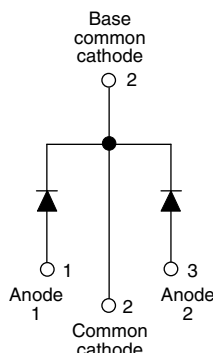


Schottky Rectifier, 2 x 15 A



TO-247AC



FEATURES

- 175 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Designed and qualified according to JEDEC-JESD47
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



PRODUCT SUMMARY

Package	TO-247AC
I _{F(AV)}	2 x 15 A
V _R	140 V, 150 V
V _F at I _F	0.78 V
I _{RM} max.	15 mA at 125 °C
T _J max.	175 °C
Diode variation	Common cathode
E _{AS}	11.25 mJ

DESCRIPTION

The VS-30CPQ... center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I _{F(AV)}	Rectangular waveform	30	A
V _{RRM}		150	V
I _{FSM}	t _p = 5 μs sine	1000	A
V _F	15 A _{pk} , T _J = 125 °C (per leg)	0.78	V
T _J		- 55 to 175	°C

VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-30CPQ140PbF	VS-30CPQ140-N3	VS-30CPQ150PbF	VS-30CPQ150-N3	UNITS
Maximum DC reverse voltage	V _R	140	140	150	150	V
Maximum working peak reverse voltage	V _{RWM}					

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current per device See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 135 °C, rectangular waveform	30	A
			15	
Maximum peak one cycle non-repetitive surge current per leg See fig. 7	I _{FSM}	5 μs sine or 3 μs rect. pulse	1000	
		10 ms sine or 6 ms rect. pulse	340	
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 0.50 A, L = 90 mH	11.25	mJ
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical	0.50	A

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum forward voltage drop per leg See fig. 1	$V_{FM}^{(1)}$	15 A	1.00	V
		30 A	1.19	
		15 A	0.78	
		30 A	0.93	
Maximum reverse leakage current per leg See fig. 2	$I_{RM}^{(1)}$	$T_J = 25\text{ }^{\circ}\text{C}$	0.1	mA
		$T_J = 125\text{ }^{\circ}\text{C}$	15	
Maximum junction capacitance per leg	C_T	$V_R = 5\text{ V}_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^{\circ}\text{C}$	340	pF
Typical series inductance per leg	L_S	Measured lead to lead 5 mm from package body	7.5	nH
Maximum voltage rate of change	dV/dt	Rated V_R	10 000	V/ μ s

Note⁽¹⁾ Pulse width < 300 μ s, duty cycle < 2 %**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T_J, T_{Stg}		- 55 to 175	$^{\circ}\text{C}$
Maximum thermal resistance, junction to case per leg	R_{thJC}	DC operation See fig. 4	2.20	$^{\circ}\text{C/W}$
Maximum thermal resistance, junction to case per package		DC operation	1.10	
Typical thermal resistance, case to heatsink	R_{thCS}	Mounting surface, smooth and greased	0.24	
Approximate weight			6	g
			0.21	oz.
Mounting torque	minimum		6 (5)	kgf · cm (lbf · in)
	maximum		12 (10)	
Marking device		Case style TO-247AC (JEDEC)	30CPQ140	
			30CPQ150	

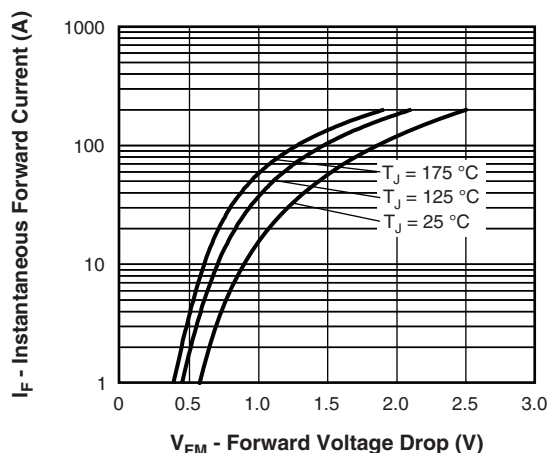


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

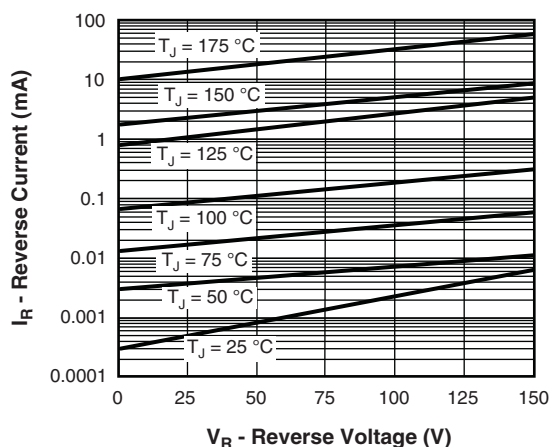


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

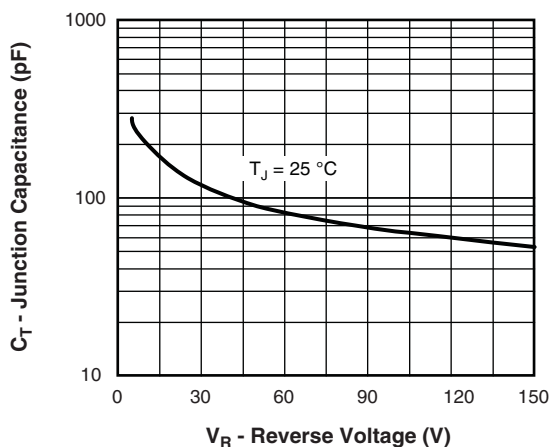


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

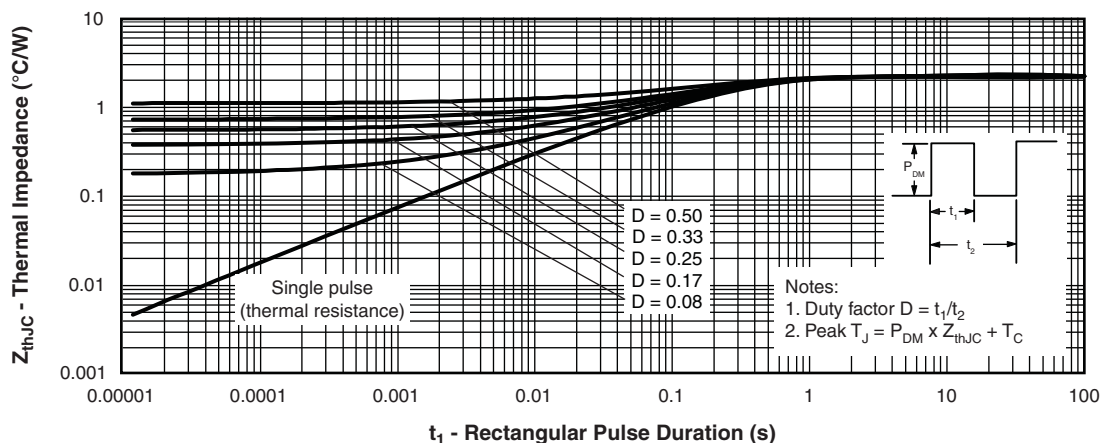


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

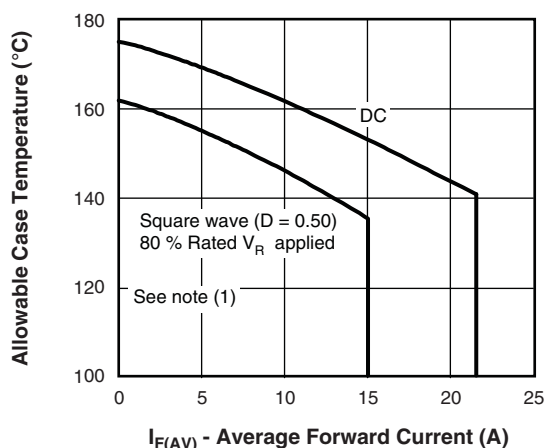


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

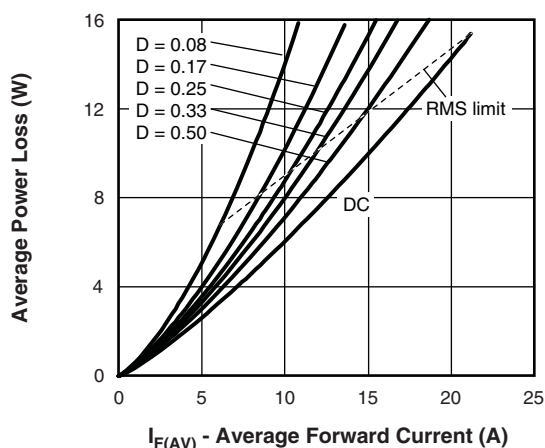


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

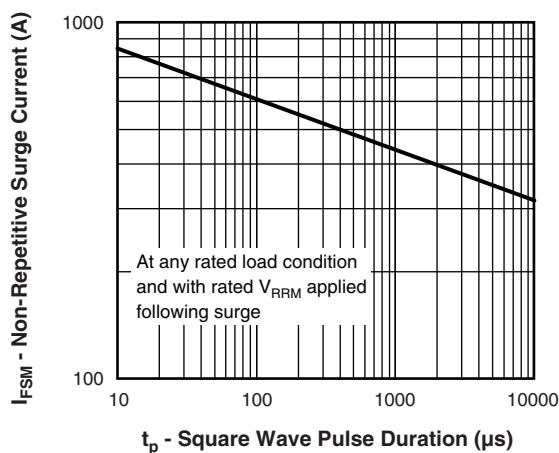


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

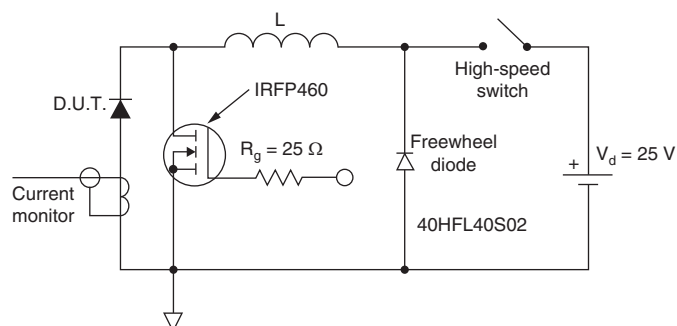


Fig. 8 - Unclamped Inductive Test Circuit

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80\%$ rated V_R



ORDERING INFORMATION TABLE

Device code	VS-	30	C	P	Q	150	PbF
	1	2	3	4	5	6	7
1	Vishay Semiconductors product						
2	Current rating (30 = 30 A)						
3	Circuit configuration: C = Common cathode						
4	Package: P = TO-247						
5	Schottky "Q" series						
6	Voltage code						
7	Environmental digit						
	• PbF = Lead (Pb)-free and RoHS compliant						
	• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free						

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-30CPQ140PbF	25	500	Antistatic plastic tube
VS-30CPQ140-N3	25	500	Antistatic plastic tube
VS-30CPQ150PbF	25	500	Antistatic plastic tube
VS-30CPQ150-N3	25	500	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95542
Part marking information	TO-247ACPbF www.vishay.com/doc?95226
	TO-247AC-N3 www.vishay.com/doc?95007



TO-247 - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
c	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
e	5.46 BSC		0.215 BSC		
Ø K	0.254		0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.3		
Ø P	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q



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